

Temperature Aware Phase/Frequency Detector-based RO-PUFs Exploiting Bulk-Controlled Oscillators

Sha Tao and Elena Dubrova

School of ICT, KTH Royal Institute of Technology

Email: {stao,dubrova}@kth.se

Abstract—Physical unclonable functions (PUFs) are promising hardware security primitives suitable for low-cost cryptographic applications. Ring oscillator (RO) PUF is a well-received silicon PUF solution due to its ease of implementation and entropy evaluation. However, the responses of RO-PUFs are susceptible to environmental changes, in particular, to temperature variations. Additionally, a conventional RO-PUF implementation is usually more power-hungry than other PUF alternatives. This paper explores circuit-level techniques to design low-power RO-PUFs with enhanced thermal stability. We introduce a power-efficient approach based on a phase/frequency detector (PFD) to perform pairwise comparisons of ROs. We also propose a temperature compensated bulk-controlled oscillator (BCO) and investigate its feasibility and usage in PFD-based RO-PUFs. Evaluation results demonstrate that the proposed techniques can effectively reduce the thermally induced errors in PUF responses while imposing a low power overhead. The PFD-based BCO-PUF is one of the best among existing RO-PUFs in terms of power efficiency.

I. INTRODUCTION

Physical unclonable functions (PUFs) which extract inherent randomness in physical devices have recently emerged as a light-weight cryptographic primitive. Over the past decade, PUFs have found their usage in many practical applications such as device identification, authentication, secret key generation and storage [1], [2]. Among different solutions, the most popular and low-cost PUFs are based on uncontrollable and unpredictable process variations during silicon manufacturing. From an implementation perspective, most existing silicon PUFs can be widely divided into three categories: (1) delay-based, including arbiter PUFs [1] and ring oscillator (RO) PUFs [2], (2) bistable element-based, such as SRAM-PUFs [3] and bistable ring PUFs [4], and (3) other PUFs based on customized circuit blocks [5], [6]. An extensive characterization and comparative study of different silicon PUFs fabricated on the same CMOS technology can be found in [7].

A. Prior Related Works

Among many PUF variants, the PUF structure based on comparing the frequency difference of ring oscillator pairs, called RO-PUF, has become a popular solution due to its ease of implementation and entropy evaluation [2]. For reliable identification and authentication, PUF designs are expected to provide stable responses under varying operating conditions. However, the frequency of ROs changes with varying environment. In addition, the rate of change in frequency can also vary for different ROs. These, in turn, lead to unstable responses.

In this subsection, we review existing reliability enhancement methods applied specifically to RO-PUFs. Error correc-

tion codes (ECCs) have been traditionally applied to RO-PUFs to produce error-free responses [8]. However, ECCs usually impose high overhead, which also scales up quickly with the increased number of error correction bits [9]. Alternatively, various architectural and circuit level techniques have been proposed in the literature to improve reliability of RO-PUFs.

From an architectural perspective, the first RO-PUF design [2] employs a 1-out-of-N masking scheme that selects only those pairs with frequency differences sufficiently large to overwhelm environmental noise. In [10], a temperature-aware cooperative RO-PUF is proposed, which defines a bit-generation rule so as to convert unreliable bits into reliable ones. A more hardware-efficient approach is suggested in [11], where a feedback-based supply control scheme is used to vary supply voltage according to operating temperature. Another approach, introduced in [12], improves the reliability of RO-PUFs against temperature variation through applying multiple supply voltages on different inverters in each RO.

From a circuit perspective, one way of increasing the stability of RO-PUFs against supply variation is to operate the transistors with a forward body bias [13]. In [14], two methods for reducing temperature sensitivity of delay based PUFs are proposed. The first finds an optimum power supply under which temperature effects are minimized. The second uses negative temperature coefficient resistance to compensate for temperature effects of inverters. Both methods are applied to a conventional RO-PUF and a phase differential RO-PUF proposed in [15]. Most recently, a hybrid RO-PUF is proposed [16], which uses the positive temperature coefficient of current starved inverters to offset the response instability due to the negative temperature coefficient of regular inverters. Furthermore, in [17], the impact of aging effect is addressed, and the first aging-resistant PUF design is presented.

B. Contributions and Organization

In this work, we aim to counteract the effect of temperature-induced frequency errors in ring oscillators, which is considered to be a major problem that can notably degrade the reliability of a RO-PUF. Our contributions can be summarized as follows: (1) We investigate and compare two circuit-level techniques for realizing temperature compensated ROs, namely, bulk-controlled oscillator (BCO) and current-starved voltage-controlled oscillator (CSVCO). (2) Inspired by the topology in [15], we propose an alternative method based on a phase/frequency detector (PFD) to extract difference

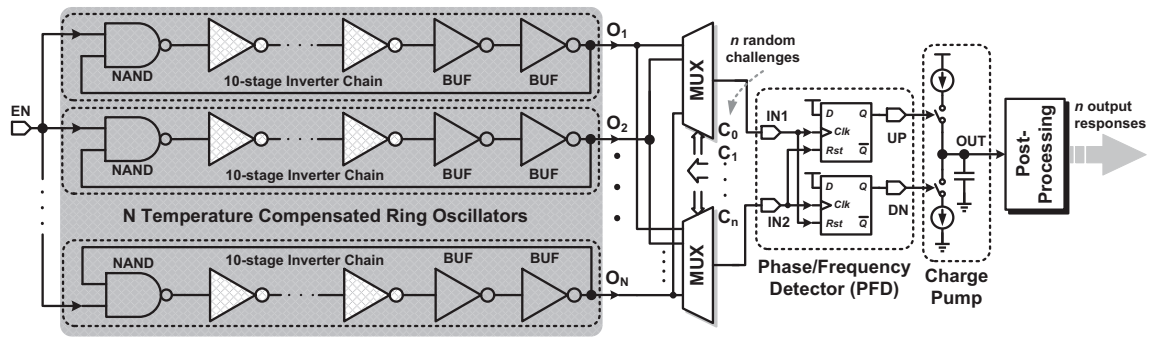


Fig. 1: Block diagram of the proposed temperature aware PUF.

in RO pairs for reliable PUF response generation. (3) We demonstrate that the proposed design is effective for reducing the error-rate in PUF responses over temperatures and shows satisfying resistance to supply ripples while featuring a low power overhead comparable to the state-of-the-art designs.

The rest of this paper is organized as follows. In Section II, we describe the proposed PFD-based PUF and elaborate the design and analysis of its circuit blocks. The experimental methodology and PUF evaluation results are presented and discussed in Section III. Section IV concludes the paper.

II. PROPOSED PUF DESIGN

The concept of the proposed temperature aware PUF is illustrated in Fig. 1. To generate a response, one pair of temperature compensated ROs is enabled and selected by two multiplexers that are controlled by a random challenge. Unlike conventional RO-PUFs that use power- and time-consuming counters and comparators to compare oscillating frequencies, the proposed PUF employs a phase/frequency detector (PFD) followed by a charge pump (CP) which are widely used in phase-locked loops (PLLs) for clock generation [18].

A. RO-PUFs based on Phase/Frequency Detector

Fig. 2 shows the schematic and timing diagram of the designed PFD and CP [19]. The PFD, consisting of two D flip-flops (DFFs) [20], compares the leading edges of two signals, 'IN1' and 'IN2', coming from two selected ROs. The outputs of PFD, 'UP' and 'DN', depend on both phase and frequency differences between two input signals. For instance, Fig. 2 (b) illustrates the case of 'IN1' leading 'IN2': 'UP' goes high when there is a rising edge on 'IN1' and is reset by a rising edge on 'IN2'. The transition is similar for the case shown in Fig. 2 (c) where 'IN2' is faster. The 'UP' and 'DN' signals control the CP consisting of two switched current sources: when 'UP' is high and 'DN' is low, the load capacitor is charged thus raising the voltage of 'OUT'; when 'DN' is high and 'UP' is low, the load capacitor is discharged thus reducing the voltage of 'OUT'; when both 'UP' and 'DN' are low, both switches are off and thus the voltage of 'OUT' remain unchanged. By the end of each enable period, 'OUT' can be captured by a logic analyzer in practice with thresholds $V_{TH} = V_{TL} = V_{DD}/2$.

Compared to the phase differential RO-PUF [15] that uses a latched comparator to sense an instant output voltage differ-

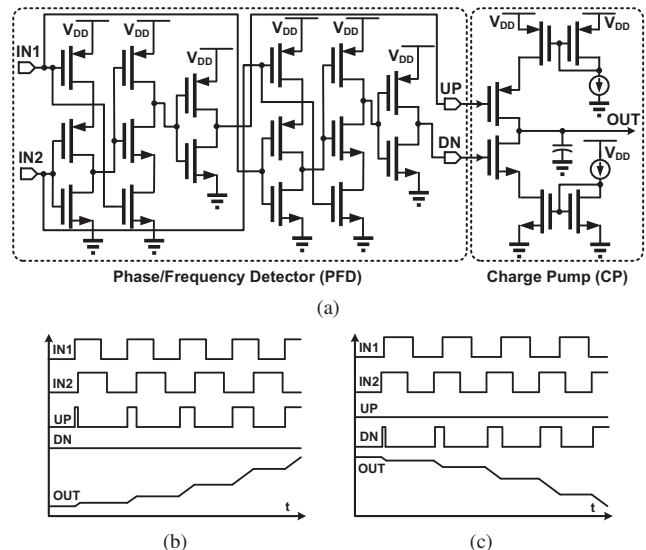


Fig. 2: PFD and CP: (a) circuit schematics, (b) timing diagram when $f_{IN1} > f_{IN2}$, and (c) timing diagram when $f_{IN1} < f_{IN2}$.

ence of two ROs at the end of an enable signal 'EN', our PFD-based approach not only consumes less power, but also provides better comparison accuracy, since the phase/frequency difference of two ROs is accumulated for a period and thus gets "amplified" rather than being decided at once. Moreover, reliability of this PFD-based approach will not be degraded by the jitter of the enable signal 'EN'. On the other hand, in this approach, since the result is not directly dependant on the duration of 'EN', we cannot apply the area-efficient method in [15], where 'EN' with various pulse widths are used as challenges feeding into the same RO pair.

Like in conventional RO-PUFs, to generate n output responses with maximum entropy, the total number of ROs, N , needs to satisfy: $\log_2(N!) \geq n$ [2]. For instance, to generate $n = 128$ independent bits, $N = 36$ ring oscillators are required. We can use the redundant $\log_2(36!) - 128 \approx 10$ bits to perform an optional data screening (DS) at post-processing. The DS eliminates 10 out of 138 output responses while the candidates are determined according to the detected phase/frequency difference. We remove the responses generated by 10 RO pairs with the minimum absolute value of 'OUT', which can be recorded by an oscilloscope in practice.

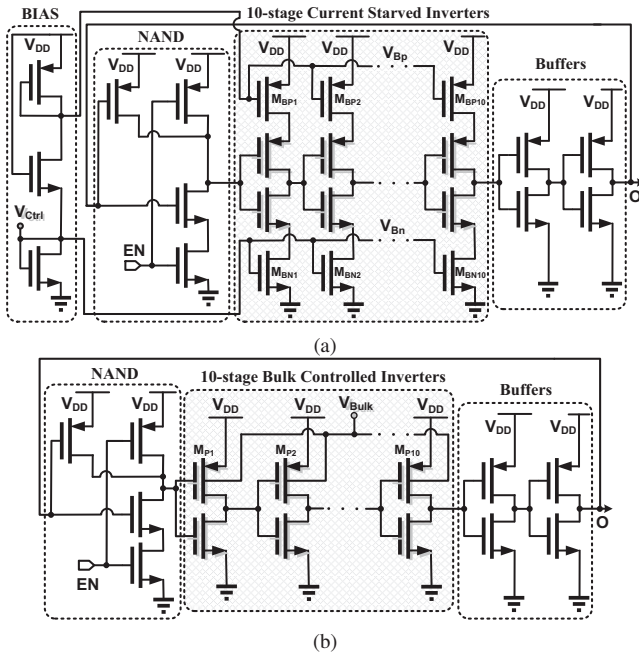


Fig. 3: (a) Schematic of (a) current-starved voltage-controlled oscillator (CSVCO) and (b) bulk-controlled oscillator (BCO).

B. Temperature Compensated Bulk-Controlled Oscillators

Voltage controlled oscillator (VCO) is the core building block of PLL circuits. VCOs which employ current starvation to control their output frequencies are called current-starved VCO (CSVCO) [21]. However, the relationship between output frequency and input control voltage is very non-linear in CSVCOs. Alternatively, controlling the frequency through tuning the bulk voltage of transistors can alleviate the linearity issue [22]. In this subsection, we introduce a bulk-controlled oscillator (BCO) with dynamic temperature correction to be used in the proposed PUF. We investigate its hardware overhead and its feasibility in minimizing frequency errors due to environmental changes. We also demonstrate the advantages of this BCO based approach over its CSVCO based counterpart.

Fig. 3 (a) shows the schematic of a CSVCO consisting of a 10-stage CS inverter chain whose delay is controlled by V_{Ctrl} , buffer inverters whose delays are made negligible compared to the CS inverter chain, and a NAND gate to enable or disable the RO. It has been shown in [23] that using CS inverters in delay-based PUF circuits is beneficial, as they can increase the standard deviation of delay compared to regular inverters. For ROs, this advantage remains. The control voltage V_{Ctrl} modulates the on-resistance of current source transistors M_{BN1} $BN10$ and M_{BP1} $BP10$ through a BIAS circuit. These variable resistances regulate peak current available at each inverter stage and thus vary its propagation delay which, in turn, controls the frequency of RO. The frequency of CSVCO, f_{OSC} , is proportional to $(V_{Ctrl} - V_{th})^2$ when the current source transistors are in saturation [21]. Fig. 4 (a) illustrates the simulation results when V_{DD} is 0.9V, showing that the f_{OSC} increases with increasing V_{Ctrl} in a non-linear way. To maximize the mismatch, the core inverters are biased in

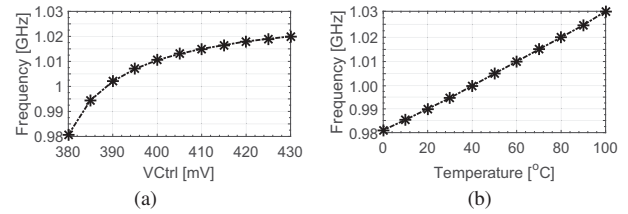


Fig. 4: Frequency of CSVCO vs. (a) V_{Ctrl} and (b) temperature.

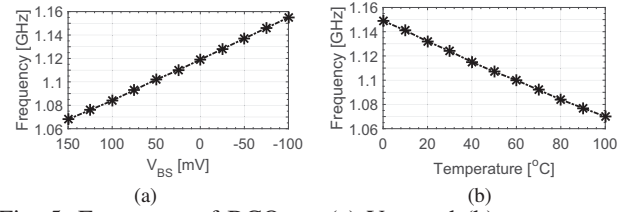


Fig. 5: Frequency of BCO vs. (a) V_{BS} and (b) temperature.

the weak inversion region. In this region, with the increase of temperature, the decrease of threshold $V_{th}(T)$ dominates the decrease of mobility $\mu(T)$ [16]. Additionally, the current at each stage is proportional to $\mu(T)$ and inversely related to $V_{th}(T)$. Thus, f_{OSC} of the CSVCO increases with the increase of temperature. This is confirmed by the simulation results shown in Fig. 4 (b).

Alternatively, we can solve the linearity issue in the CSVCO by controlling the bulk potential of inverters. Fig. 3 (b) shows the schematic of a BCO, which replaces the CS inverters in Fig. 3 (a) with regular inverters. The bulk of all PMOS¹, M_{P1} $P10$, is connected to a control voltage V_{Bulk} . When PMOS is biased to a potential other than V_{DD} , its threshold voltage is proportional to $\gamma(\sqrt{2\phi_f - V_{BS}})$ [22], where γ is a process constant and ϕ_f is the surface potential of the PMOS. Therefore, when V_{BS} increases, V_{th} reduces, leading to an increased current at each stage and, consequently, an increase of f_{OSC} . This is confirmed by the simulation results illustrated in Fig. 5 (a) (V_{DD} is 0.9V). It shows a linear relationship between the frequency of BCO and the bulk-to-source potential V_{BS} although its tuning range is smaller than the one of CSVCO. Inverters in the BCO operate in the saturation region, where with the increase of temperature, the decrease of mobility $\mu(T)$ dominates the decrease of threshold $V_{th}(T)$ [14]. Thus, when temperature is increased, the overall current is reduced leading to a decrease in frequency. This is confirmed by the simulation results shown in Fig. 5 (b).

From the above analysis, we can see that the thermal effect of CSVCO and BCO can be compensated by adjusting² their control voltages V_{Ctrl} and V_{Bulk} , respectively. In Fig. 6, we compare the resulting frequency errors with respect to the reference frequency at 25°C of two temperature compensated ROs³. Compared to CSVCO, the BCO based approach is

¹We control the bulk of PMOS not NMOS due to the following reasons: (1) Biasing the bulk of NMOS requires a triple well CMOS process while biasing the bulk of PMOS can be applied to any standard CMOS process. (2) Creating a bias voltage around V_{DD} for PMOS is more straightforward and easier than creating a bias voltage around G_{ND} for NMOS.

²Next paragraph will explain how these two voltages are adjusted.

³For fair comparison, both ROs oscillate at a similar nominal frequency. Thus, BCO is power by 0.9V and CSVCO uses a higher supply of 1V.

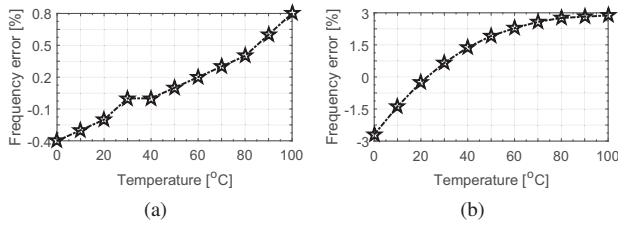


Fig. 6: Frequency error (compared to the reference at 25°C) after temperature compensation: (a) BCO and (b) CSVCO.

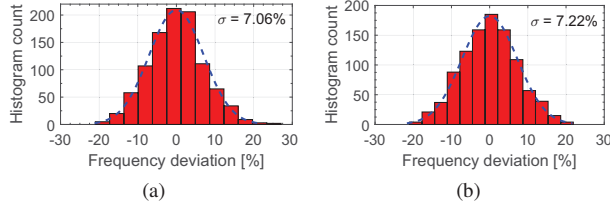


Fig. 7: Histogram of the frequency deviation obtained from 1000 Monte-Carlo simulations: (a) BCO and (b) CSVCO.

much more effective in reducing temperature sensitivity: the frequency error is limited to less than 1%. Fig. 7 plots the distribution of relative frequency deviation due to process variation obtained from 1000 instances of each RO, indicating that the “desired” frequency deviation among different PUF instances is larger than the “undesired” frequency error due to temperature changes. The averaged current consumed by BCO and CSVCO is 14.55 μ A and 21.34 μ A, respectively⁴. Fig. 8 shows the layouts of two ROs, implemented manually in Cadence Virtuoso. Thanks to the elimination of 20 chunky current source transistors used for current starvation, BCO is much more area-efficient than CSVCO. The chip area of the BCO and CSVCO is 39.27 μ m² and 613.74 μ m², respectively.

Fig. 9 illustrates an implementation example of the voltage references^{5,6} for the proposed BCO and CSVCO, which are derived from a 1.2V external reference $V_{DD,ext}$. Fig. 10 shows their simulation results. Both control voltages are generated by a simple NMOS voltage divider, whose output V_{Bulk} or V_{Ctrl} has a negative temperature coefficient (TC) and thus decreases with increasing temperature. On the other hand, the supply voltage V_{DD} for both ROs should not be sensitive to temperature changes. As shown in Fig. 9, a voltage divider consisting of both PMOS and NMOS is used to generate such a temperature insensitive reference⁷. The basic idea is to use the positive TC of PMOS threshold ($-\frac{\partial V_{th,P}}{\partial T} > 0$) to compensate the negative TC of NMOS threshold ($\frac{\partial V_{th,N}}{\partial T} < 0$), so as to achieve an almost zero TC [21] at the output.

Next, we briefly discuss the impact of supply variation on both ROs. In both cases, when $V_{DD,ext}$ varies, V_{DD} , V_{Bulk} and V_{Ctrl} follow the voltage changes accordingly in the same

⁴Note that the CSVCO can have a much less current consumption with a much lower f_{OSC} when biased towards deep weak-inversion.

⁵In addition to regular transistors (RVT), high threshold voltage (HVT) NMOS transistors are used in the design to reduce static current consumption.

⁶Note that these voltage references can be shared by all ROs in the PUF IC in order to minimize hardware overhead.

⁷In practice, such a temperature-resistance V_{DD} can be generated by a bandgap voltage reference, e.g. a low power bandgap presented in [24].

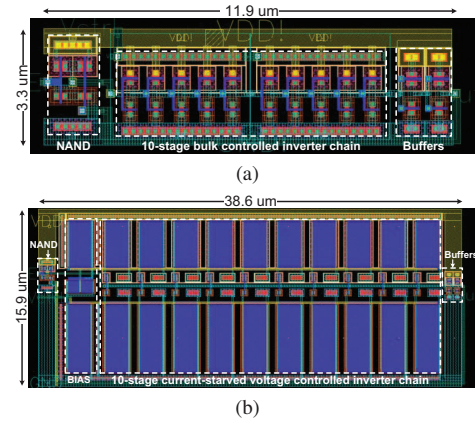


Fig. 8: Layouts of (a) BCO and (b) CSVCO.

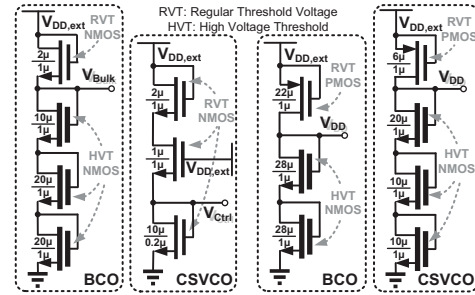


Fig. 9: Voltage reference generation circuits.

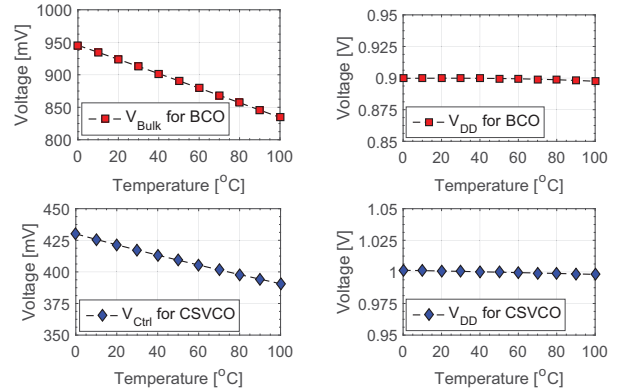


Fig. 10: Temperature dependency of voltage references.

direction. For instance, when $V_{DD,ext}$ decreases, a drop in both V_{DD} reduces the f_{OSC} of both ROs. For BCO, a drop in V_{Bulk} reduces the V_{BS} , and thus increases the f_{OSC} according to Fig. 5 (a). For CSVCO, on the other hand, a drop in V_{Ctrl} reduces the current at each CS inverter stage, and thus further decreases the f_{OSC} . Therefore, in comparison with its CSVCO counterpart, the BCO based approach has another advantage in minimizing the PUF’s sensitivity to supply noise.

III. EVALUATION RESULTS

A. Methodology

The PUF circuits were designed using UMC 65 nm CMOS technology and simulated using Cadence Spectre. Matlab was used to perform post-processing and compute performance metrics. The nominal operating condition was at 25°C with

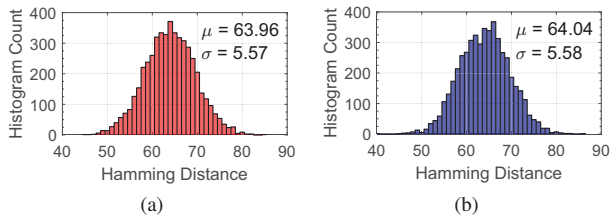


Fig. 11: Distribution of inter-chip HD obtained from 100 chip instances of (a) BCO-PUF and (b) CSVCO-PUF.

$V_{DD} = 0.9V$ for BCO-PUF and $V_{DD} = 1V$ for CSVCO-PUF. To emulate the characterization of 100 different PUF IC chips, 100 runs of Monte-Carlo simulations were performed. Realistic models provided by a commercial foundry were used in the simulations. Both process and mismatch options were enabled to account for intra-die and inter-die variations. Such a transistor-level Monte-Carlo simulation based experimental methodology has been adopted in many PUF publications, e.g., [3], [4], [9], [11], [13]–[15], [17], [23].

B. Uniqueness Analysis

We first evaluate the PUF’s uniqueness, U , at the nominal condition, using the average inter-chip Hamming Distance (HD_{inter}) of the responses from k different PUF instances:

$$U = \frac{2}{k(k-1)} \sum_{i=1}^k \sum_{j=i+1}^k \frac{HD(R_i, R_j)}{n} \times 100\%,$$

where R_i and R_j are the n -bit responses of instances i and j . Perfect identification of different chips requires $HD_{inter} = n/2$ and $U = 50\%$. For both PUFs, we applied 128 random challenges to each of $k = 100$ instances. So, $100 \times 99/2 = 4950$ comparisons were used to compute the HD_{inter} . As shown in Fig. 11, the average HD_{inter} of two PUFs are 63.96 and 64.04, corresponding to the uniqueness of 49.97% and 50.03%, respectively.

C. Randomness and Entropy

Randomness is typically evaluated by counting the proportion of ‘0’s or ‘1’s in PUF responses. Ideally, this proportion should be very close to 50%, since any bias towards ‘0’ or ‘1’ makes the PUF responses predictable and easier to attack. Fig. 12 (a) and (b) depict output responses from 100 IC instances of BCO-PUF and CSVCO-PUF, characterized at the nominal condition, showing no systematic pattern or noticeable correlation among response bits. The maximum autocorrelation of the response bits of BCO-PUF and CSVCO-PUF calculated using Matlab built-in *autocorr* function are 0.0196 and 0.0214, respectively. Assuming independent responses, randomness of PUF responses can also be evaluated by Shannon entropy, $H = -p_1 \log_2 p_1 - (1-p_1) \log_2 (1-p_1)$, where p_1 is the proportion of ‘1’s in n response bits. Entropy H approaches the ideal value of 1 when p_1 approaches 50%. Fig. 13 shows that the average entropy of BCO-PUF and CSVCO-PUF are 0.9944 and 0.9923, respectively.

D. Reliability Against Temperature Variation

Reliability is related to the average intra-chip Hamming Distance (HD_{intra}) among responses of the same PUF instance obtained at varying environmental conditions. We characterized

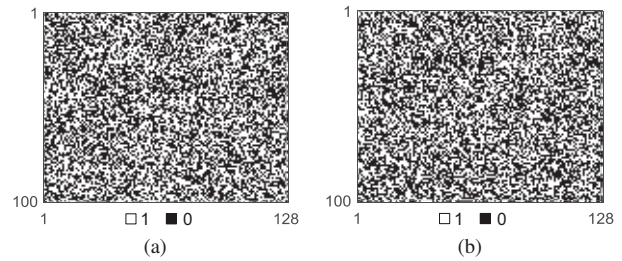


Fig. 12: Monte-Carlo simulation results of 100×128 -bit output responses for (a) BCO-PUF and (b) CSVCO-PUF.

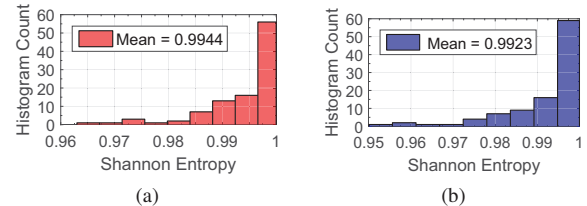


Fig. 13: Entropy of (a) BCO-PUF and (b) CSVCO-PUF.

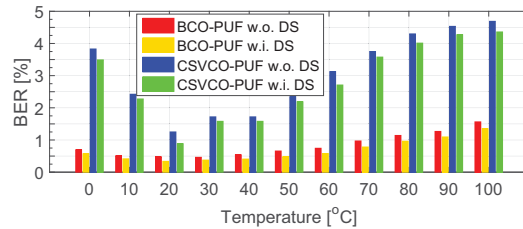


Fig. 14: Temperature reliability: BCO-PUF vs. CSVCO-PUF.

100 instances of each PUF at different temperatures, and for each instance computed how many responses bits are changed out of the total $n = 128$ responses. This ratio in percentage is defined as the bit error rate (BER): $BER = \frac{HD(R_i, R'_i)}{128} \times 100\%$, where $HD(R_i, R'_i)$ represents the HD_{intra} , R_i is ground truth response of instance i , and R'_i is the response taken at a different temperature. As shown in Fig. 14, with (w.i.) or without (w.o.) data screening (DS), BCO-PUF is less sensitive to temperature variation compared to CSVCO-PUF.

E. Resistance to Side-Channel Attacks

RO-PUFs are potentially vulnerable to two types of side-channel attacks [25], [26]: passive power analysis attack and active fault injection attack. Regarding the passive attack, for conventional RO-PUFs with power consuming counters, it is possible to extract the frequencies of ROs by observing power traces and identifying periodic peaks when counters are toggling. The proposed PFD-based RO-PUF dissipates much less power in the DFFs and thus potentially alleviates this issue. With respect to the active attack, we injected a $\pm 10\%$ power supply ripple during PUF operation, following the method described in [25]. Simulation results show that the average BER induced by such a supply ripple attack is only 0.53% and 1.21% for BCO-PUF and CSVCO-PUF.

F. Performance Summary and Future Works

Table I summarizes performance metrics of the proposed BCO-PUF in comparison with CSVCO-PUF. Table II com-

TABLE I: Performance summary of proposed PUFs.

	BCO-PUF	CSVCO-PUF
Output Throughput	50M bps	
Response Size	128 bits	
Transistor Count	1106	1934
Power (ROs)	28.7 μ A \times 0.9V	42.2 μ A \times 1V
Power (PFD+CP)	11.6 μ A \times 0.9V	12.7 μ A \times 1V
Average Entropy	0.9944	0.9923
Uniqueness (μ , σ)	(49.97%, 5.57%)	(50.03%, 5.58%)
Temperature Range	0°C to 100°C	
Average BER w.i. DS	0.67%	2.81%
Average BER w.o. DS	0.82%	3.06%
Supply Fault Attack	\pm 10% supply ripple	
Average BER	0.53%	1.21%

TABLE II: Comparison to low-power RO-PUF ASICs.

	Tech-nology	RO Freq.	Power per CRP
[15] Optimized supply RO-PUF*	45nm	2.9GHz	82 μ W
[15] Negative resistance RO-PUF*	45nm	2.6GHz	98 μ W
[15] Phase differential RO-PUF ⁺	45nm	–	80 μ W
[16] Hybrid RO-PUF	65nm	0.32GHz	32.3 μ W
This work: BCO-PUF	65nm	1.13GHz	36.4 μ W

* Excluding power consumed by multiplexers and counters.

⁺ Excluding power consumed by sense amplifier.

compares the proposed BCO-PUF to existing RO-PUF ASICs. Note that many RO-PUFs in the literature are not power aware designs and hence do not report their power overhead. Therefore, in this comparison, we only include existing low-power RO-PUF ASICs with available power metrics. We can see that the proposed temperature aware BCO-PUF is one of the best among the state-of-the-arts in terms of power efficiency. Future investigations include evaluating the reliability of PUF responses with aging effects [17]. We also plan to further analyze its security against modeling and power analysis attacks [26] and its susceptibility to tampering [27].

IV. CONCLUSION

This paper presented effective and efficient approaches for enhancing the reliability of RO-PUFs. We introduced a PFD-based alternative to the slow and power-hungry counter-and-comparator configuration. We also investigated two temperature-compensated ROs, i.e. BCO and CSVCO, and evaluated their usefulness in constructing temperature aware PUFs. Both PUF circuits were implemented in 65nm CMOS and characterized. Results show that they achieve low power, high uniqueness, and high entropy. The BCO-PUF demonstrates superior resistance to environmental variations than its CSVCO-PUF counterpart. In future works, we plan to assess the aging effects and perform further security analysis.

ACKNOWLEDGMENT

This work was supported in part by the grant No SM14-0016 from the Swedish Foundation for Strategic Research.

REFERENCES

[1] D. Lim, J. W. Lee, B. Gassend, G. Suh, M. van Dijk, and S. Devadas, "Extracting Keys from Integrated Circuits," *IEEE Trans. Very Large Scale Integr. Syst.*, vol. 13, no. 10, pp. 1200–1205, 2005.

[2] G. E. Suh and S. Devadas, "Physical unclonable functions for device authentication and secret key generation," in *ACM Des. Autom. Conf. (DAC)*, 2007, pp. 9–14.

[3] A. R. Krishna, S. Narasimhan, X. Wang, and S. Bhunia, "MECCA: A robust low-overhead PUF using embedded memory array, in *Cryptogr. Hardw. Embed. Syst. (CHES)*, 2011, pp. 407–420.

[4] Q. Chen, P. Lugli, and U. Rhrmair, "Characterization of the Bistable Ring PUF," in *Des. Autom. Test Eur. Conf. Exhib.*, 2012, pp. 1459–1462.

[5] S. Tao and E. Dubrova, "Ultra-energy-efficient temperature-stable physical unclonable function in 65 nm CMOS," *Electr. Lett.*, vol. 52, no. 10, pp. 805–806, 2016.

[6] S. Tao and E. Dubrova, "MVL-PUFs: multiple-valued logic physical unclonable functions," *Wiley Int. J. Circ. Theor. App.*, doi: 10.1002/cta.2287

[7] R. Maes, V. Rozić, I. Verbauwhede, P. Koeberl, E. van der Sluis, and V. van der Leest, "Experimental evaluation of Physically Unclonable Functions in 65 nm CMOS," in *Eur. Solid State Circuits Conf. (ESSCIRC)*, 2012, pp. 486–489.

[8] M. Yu and S. Devadas, "Secure and robust error correction for physical unclonable functions," *IEEE Des. Test Comput.*, vol. 27, pp. 4865, 2010.

[9] E. I. Vatajelu, G. Di Natale, and Paolo Prinetto, "Towards a Highly Reliable SRAM-based PUFs," in *Des. Autom. Test Eur. Conf. Exhib. (DATE)*, 2016, pp. 273–276.

[10] C. Yin and G. Qu, "Temperature-Aware Cooperative Ring Oscillator PUF," in *IEEE Int. Symp. Hardware-Oriented Secur. Trust (HOST)*, 2009, pp. 36–42.

[11] V. Vivekrajya and L. Nazhandali, "Feedback based supply voltage control for temperature variation tolerant PUFs," in *Int. Conf. VLSI Des. (VLSID)*, 2011, pp. 214–219.

[12] S. Mansouri and E. Dubrova, "Ring oscillator physical unclonable function with multi level supply voltages," *IEEE Int. Conf. Comput. Des. (ICCD)*, 2012, pp. 520–521

[13] V. Vivekrajya and L. Nazhandali, "Circuit-Level Techniques for Reliable Physically Unclonable Functions," in *IEEE Int. Symp. Hardware-Oriented Secur. Trust (HOST)*, 2009, pp. 30–35.

[14] R. Kumar, H. Chandrikakutty, and S. Kundu, "On improving reliability of delay based Physically Unclonable Functions under temperature variations," in *IEEE Int. Symp. Hardware-Oriented Secur. Trust (HOST)*, 2011, pp. 142–147.

[15] R. Kumar, V. Patil, and S. Kundu, "On Design of Temperature Invariant Physically Unclonable Functions Based on Ring Oscillators," in *IEEE Comput. Soc. Annu. Symp. VLSI (ISVLSI)*, 2012, pp. 165–170.

[16] Y. Cao, L. Zhang, C. Chang, and S. Chen, "A Low-Power Hybrid RO PUF With Improved Thermal Stability for Lightweight Applications," *IEEE Trans. Comput. Des. Integr. Circuits Syst.*, vol. 34, no. 7, pp. 1143–1147, 2015.

[17] M. Rahman, D. Forte, J. Fahrny, and M. Tehranipoor, "ARO-PUF: An aging-resistant ring oscillator PUF design," in *Des. Autom. Test Eur. Conf. Exhib. (DATE)*, 2014, pp. 1–6.

[18] B. Razavi, *Design of Analog CMOS Integrated Circuits*. McGraw-Hill, 1st Edition, 2002.

[19] T. Luich, "Cascode switched charge pump circuit," US Patent 5,473,283, National Semiconductor Corporation, 1995.

[20] W. Lee, J. Cho, and S. Lee, "A High Speed and Low Power Phase-Frequency Detector and Charge-pump," in *Asia South Pacific Des. Autom. Conf. (APCDAC)*, 1999, pp. 4–7.

[21] R. J. Baker, *CMOS Circuit Design, Layout, and Simulation*. Wiley-IEEE Press: New York, 3rd Edition, 2010.

[22] U. Wismar, D. Wisland, and P. Andreani, "Linearity of bulk-controlled inverter ring VCO in weak and strong inversion," *Analog Integr. Circuits Signal Process.*, vol. 50, no. 1, pp. 59–67, 2007.

[23] R. Kumar, V. Patil, and S. Kundu, "Design of Unique and Reliable Physically Unclonable Functions based on Current Starved Inverter Chain," in *IEEE Comput. Soc. Annu. Symp. VLSI (ISVLSI)*, 2011, pp. 165–170.

[24] A. Annema and G. Goksun, "A 0.0025mm² bandgap voltage reference for 1.1V supply in standard 0.16 μ m CMOS," in *Int. Solid-State Circuits Conf. (ISSCC)*, 2012, pp. 364–366.

[25] G. Becker and R. Kumar, "Active and passive side-channel attacks on delay based PUF designs," *Cryptology ePrint Archive*, vol. 287, 2014.

[26] X. Xu and W. Burleson, "Hybrid side-channel/machine-learning attacks on PUFs: A new threat?," in *Des. Autom. Test Eur. Conf. Exhib. (DATE)*, 2014, pp. 1–6.

[27] C. Helfmeier, C. Boit, D. Nedospasov, S. Tajik, and J. Seifert, "Physical vulnerabilities of Physically Unclonable Functions," in *Des. Autom. Test Eur. Conf. Exhib. (DATE)*, 2014, pp. 1–4.